

REMARKS

In the Office Action the Examiner rejected claims 1-13 and 15-24 under 35 U.S.C. 102 as being anticipated and objected to claim 14 as being dependent on a rejected base claim. Claims 1-24 remain under examination.

The Examiner used two references as each being anticipating references. Applicants, however, point out that all of the claims have a requirement that there be a strained semiconductor layer. In independent claims 7 and 15, there is further added the requirement of "pre" which makes reference to the semiconductor layer being strained prior to the claimed step of bonding. In all claims though the semiconductor layer must be strained. Applicants have not been able to find any such corresponding semiconductor layer in either Yamazaki or Iendo that is strained. Further applicants have not been able to find a method taught by Yamazaki or Iendo whereby a corresponding semiconductor layer would become strained. Thus, for at least this reason of the requirement of a strained semiconductor layer, applicants believe the rejection is improper and further that the claims are patentably distinct from the cited references.

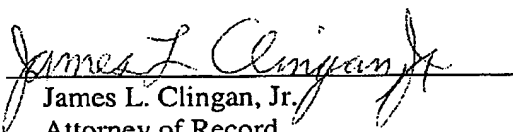
Thus applicants believe the application is in condition for allowance which action is respectfully solicited. Please contact the below-signed if there are any issues regarding this communication or otherwise concerning the current application.

Respectfully submitted,

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